

Description	The iT4050D is a wideband LVDS-to-SCFL level translator fabricated using 0.1µm HBT GaAs technology. It is based on ECL topology to guarantee high-speed operation. The two translators are fully independent, allowing power consumption to be optimized according to the application. The device can translate NRZ streams with data rate up to 3.125 Gb/s or clock signals with a frequency up to 3.125 GHz. The inputs and outputs of the iT4050D are DC coupled. At the input side, internal 100-ohm resistors between the two differential lines avoid the need for external impedance matching terminations. The input levels are fully compliant with LVDS specifications. The iT4050D uses SCFL output levels and allows either single ended or differential data output. The excellent rise and fall time and the good quality of the eye diagram at all data rates up to 3.125 Gb/s makes the iT4050D suitable for interfacing a generic LVDS output buffer with all iTerra SCFL parts.							
Features	 Wideband signal handling: Up to 3.125 Gb/s NRZ Input sensitivity: 350 mV differential 450 mV pp typical single-ended output Jitter RMS: <2 ps Output rise time (20% – 80 %): <55 ps Output rise time (20% – 80 %): <55 ps Output rise time (20% – 80 %): <55 ps Output rise time (20% – 80 %): <55 ps Output rise time (20% – 80 %): <55 ps 				S			
Absolute Maximum Ratings								
Stresses above those listed under Absolute Maximum Ratings may		Symbol	Parameters/conditions		Min.	Max.	Units	
cause permanent damage to the device. This is a stress rating		Vdd	Power supply voltage		0	2.75	V	
only; functional operation of the device at these or any other		Vee	Power supply voltage		-3.63	0	V	
conditions above those indicated in the operational section of		Vih	Input voltage level, high level		0	2.4	V	
this document is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.		VIL	Input voltage level, low level		0	2.4	V	
		Та	Operating temperature range - d	lie	-15	125	°C	
		Тѕтс	Storage temperature		-65	150	°C	

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Recommended						
Operating	Symbol	Parameters/conditions		Тур.	Max.	Units
Conditions	ТА	Operating temperature range – die	0		85	°C
	Vdd	Positive power supply voltage		2.5		V
	VEE	Negative power supply voltage		-3.3		V
	VIH	Input voltage level, high level (single ended)		1.4		V
iheet4U.com	VIL	Input voltage level, low level (single ended)		1.05		V
	VINDC	DC input voltage (with DC-coupled input)		1.22		V

Electrical Characteristics

1. Electrical characteristics at ambient temperature.

2. In case of singleended input the unused pin has to be tied to VINDC.

3. In case of singleended output, the unused pad must be terminated with 50 ohms to ground.

4. On a 3-Gb/s PRBS pattern, DC coupled output.

5. Current and power dissipation are per converter.

Symbol	Parameters/conditions	Тур.	Units
Vdd	Positive power supply voltage	2.5	V
VEE	Negative power supply voltage	-3.3	V
Vih	Input voltage level, high level (single ended)	1.4	V
VIL	Input voltage level, low level (single ended)	1.05	V
VINDC	DC input voltage (with DC-coupled input) (2)	1.22	V
Vout	Data output voltage amplitude (3)	450	mV
Vон	Output voltage level, high level (Single ended)	0	V
Vol	Output voltage level, low level (single ended)	-450	mV
Tr	Output rise time (20%-80%)	55	ps
Tf	Output fall time (20%-80%)	55	ps
S22	Output return loss (up to 7 GHz)	15	dB
Jp-p	Peak-to-peak jitter (4)	12	ps
Jrms	RMS jitter (4)	2	ps
IDD	Positive power supply current (5)	8	mA
IEE	Negative power supply current (5)	36	mA
PD	Power dissipation (5)	140	mW

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October 5, 2005 Doc. 4051 Rev 0

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Pad Positions and Chip **Dimensions** Chip size: 2900 1400 μm ±10 μm x 2900 µm ±10 µm 2790 VEE1 VDD1 Chip thickness: 104 µm ±3 µm 2590 GND GND Pad size: 2440 DIN1 DOUT1 100 µm x 100 µm 2290 GND GND RF pad pitch: 2140 DIN1/ DOUT1/ 150 µm 1990 GND GND VEE2 1790 VDD2 iT4050 VEE3 1110 VDD3 910 GND GND DIN2 DOUT2 78 GND GND 610 DIN2/ DOUT2/ 460 310 GND GND VDD4 VEE4 3 0 Ö 1400

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